



# **Application Note**

**Eon Flash EN39SL160L(H)**

**VS**

**SST Flash SST39WF1601(02)**



# Eon Silicon Solution Inc.

## 1. INTRODUCTION

The application note introduces how to implement a system design from SST SST39WF1601(02) Flash to Eon EN39SL160L(H) Flash.

## 2. GENERAL FUNCTION COMPARISON TABLE:

The following table is major features of these two devices.

Features	EN39SL160L(H)	SST39WF1601(02)
voltage range	1.65 ~ 1.95	1.65 ~ 1.95
Pin to Pin	48-ball 6mm x 8mm TFBGA ( B3 = WP#/ACC ) 48-ball 4mm x 6 mm WFBGA ( D5 =WP#/ACC )	48-ball 6mm x 8mm TFBGA ( B3 = WP# ) 48-ball 4mm x 6 mm WFBGA 48-ball 5mm x 6 mm WFBGA ( D5 = WP# )
Access time	70ns	70/90ns
Sector Architecture	512 sectors of 2K word 32 blocks of 32-Kword	512 sectors of 2K word 32 blocks of 32-Kword
Byte/Word mode	48-ball TFBGA and WFBGA only support Word Mode	only support Word Mode
VID and VHH Max	9.0V – 11.0V	None
Autoselect Command	Yes	None
WP#/ACC	Yes	only support WP#
Hardware Block Protection	Yes	Yes
CFI Compliant	Yes	Yes
Erase Suspend/Resume	Yes	Yes
Minimum endurance cycle	100K	100K
Package	48-ball 6mm x 8mm TFBGA 48-ball 4mm x 6 mm WFBGA	48-ball 6mm x 8mm TFBGA 48-ball 4mm x 6 mm WFBGA 48-ball 5mm x 6 mm WFBGA



## 3. HARDWARE CONSIDERATIONS

### 3.1 I<sub>CC</sub> comparison

Current	EN39SL160L/H		SST39WF1601/02		Unit
	Typ	Max	Typ	Max	
Read I <sub>CC1</sub>	5	10	-	10	mA
Write I <sub>CC4</sub>	15	25	-	25	mA
Standby I <sub>CC2</sub>	0.2	5.0	-	40	μA

### 3.2 Hardware Block-Protection comparison

Block-Protection Area	Eon	SST
Lowest address (Bottom) block	EN39SL160L	SST39WF1601
Highest address (Top) block	EN39SL160H	SST39WF1602

### 3.3 48-ball package comparison

- For the 48-ball (6mm x 8mm) TFBGA, the Eon EN39SL160L(H)-70BIP is the same as SST SST39WF1601/02 except B3 ball.

Part No.	EN39SL160L(H)-70BIP	SST39WF1601(02)-70(90)-4I(C)-B3KE
B3 ball	WP#/ACC	WP#

- For the ball-out of 48-ball WFBGA, the Eon EN39S160L(H)-70NIP is the same as SST SST39WF1601/02 except D5 ball.

Part No.	EN39SL160L(H)-70NIP	SST39WF1601(02)-70(90)-4I(C)-Y1(MB)QE
D5 ball	WP#/ACC	WP#

**Note:**

SST39WF1601(02) WP# pin contains internal pull-up; when unconnected, WP# is at V<sub>IH</sub> to write unprotect. But EON EN39SL160L(H) Flash WP#/ACC pin can't leave floating and need to input V<sub>IH</sub> or V<sub>IL</sub>.



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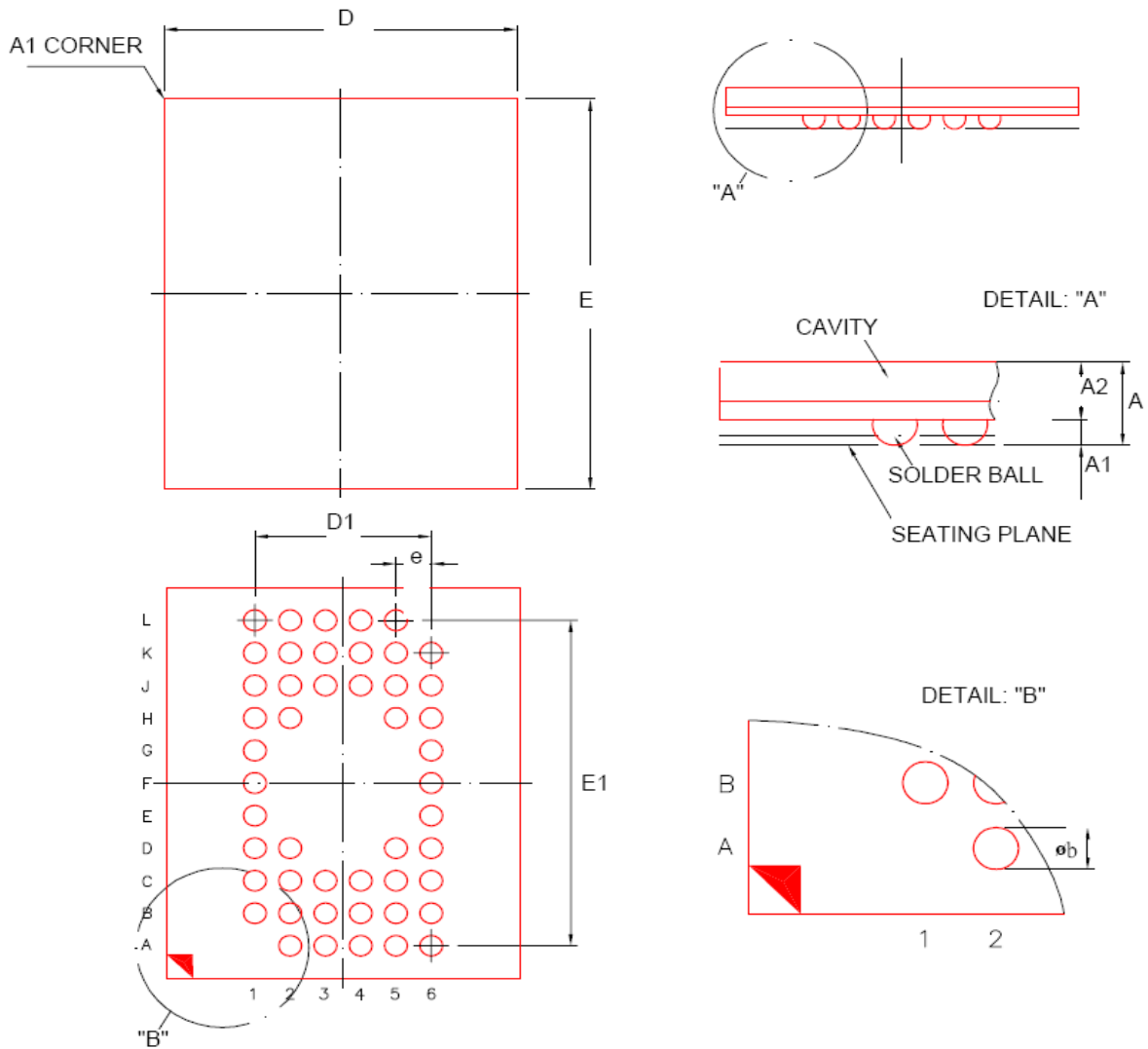
- For the package dimension of 48-ball WFBGA, the Eon EN39S160L(H)-70NIP is the same as SST SST39WF1601(02)-xx-xx-MBQE except D dimension (from 5mm change to 4mm). The customer can replace SST39WF1601(02) with EN39SL160L(H) on PCB for system design directly.

The detail information please refers to the table and 48-ball WFBGA package outline are shown below.

Part No.	EN39SL160L(H)-70NIP	SST39WF1601(02)-Y1QE	SST39WF1601(02)-MBQE
48-ball WFBGA	4mm x 6mm	4mm x 6mm	5mm x 6mm



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Part No.	EN39SL160L(H)-70NIP (4mm x 6mm) WFBGA D = 4.0 ± 1			SST39WF1601(02)-70(90)-4I(C)-MBQE (5mm x 6mm) WFBGA D = 5.0 ± 0.08		
SYMBOL	DIMENSION IN MM			DIMENSION IN MM		
	MIN.	NOR	MAX	MIN.	NOR	MAX
A	---	---	0.73	0.53	0.63	0.73
A1	0.15	0.20	0.25	0.14	0.20	0.26
A2	---	0.436	---	---	0.436	---
D	3.90	4.00	4.10	4.92	5.00	5.08
E	5.90	6.00	6.10	5.92	6.00	6.08
D1	---	2.50	---	---	2.50	---
E1	---	5.00	---	---	5.00	---
e	---	0.50	---	---	0.50	---
øb	0.25	0.30	0.35	0.27	0.32	0.37
Note :	Coplanarity: 0.1 mm			Coplanarity: 0.08 mm		



## 4. SOFTWARE CONSIDERATIONS

### 4.1 Manufacturer and Device Identification comparison

#### For EN39SL160L(H) autoselect mode table

Description		CE#	OE#	WE#	A19 to A12	A11 to A10	A9 <sup>2</sup>	A8	A7	A6	A5 to A2	A1	A0	DQ8 to DQ15	DQ7 to DQ0
Manufacturer ID: Eon		L	L	H	X	X	V <sub>ID</sub>	H <sup>1</sup> L	X	L	X	L	L	X	1Ch 7Fh
Device ID (top boot block)	Word	L	L	H	X	X	V <sub>ID</sub>	X	X	L	X	L	H	27h	4Ah
	Byte	L	L	H										X	4Ah
Device ID (bottom boot block)	Word	L	L	H	X	X	V <sub>ID</sub>	X	X	L	X	L	H	27h	4Bh
	Byte	L	L	H										X	4Bh
Block Protection Verification		L	L	H	SA	X	V <sub>ID</sub>	X	X	L	X	H	L	X	01h (Protected)
														X	00h (Unprotected)

**Note:**

1. If a manufacturing ID is read with A8=L, the chip will output a configuration code 7Fh. A further Manufacturing ID must be read with A8=H.
2. A9 = V<sub>ID</sub> is for HV A9 Autoselect mode only. A9 must be ≤ V<sub>CC</sub> (CMOS logic level) for Command Autoselect Mode.

#### For SST39WF1601(02) Manufacturer ID and Device ID

- **Manufacturer ID : 00BFH**
- **Device ID :**  
**SST39WF1601 : 274BH**  
**SST39WF1602 : 274AH**

	Address	Data
Manufacturer's ID	0000H	BFH
Device ID		
SST39WF1601	0001H	BF274B
SST39WF1602	0001H	BF274A

**For the EN39SL160L(H), the Device ID is the same as SST39WF1601(02) except the Manufacturer ID.**



## 4.2. Address input for command cycles:

### **EN39SL160L(H) :**

use address input **555H and 2AAH** for command cycles.

Address bits  $A_{10}$ -  $A_0$  are input for 555H and 2AAH, address bits  $A_{17}$ -  $A_{11}$  are don't cares.

### **SST39WF1601(02) :**

use address input **5555H and 2AAAH** for command cycles.

Address bits  $A_{14}$ -  $A_0$  are input for 5555H and 2AAAH, address bits  $A_{17}$ -  $A_{15}$  are don't cares.

The address input in the command sequence for the SST39WF1601(02) can also be used for the EN39SL160L(H) without any change.



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## Revisions List

Revision No	Description	Date
A	Initial Release	2009/07/10
B	Add the note of WP#/ACC pin on page 3.	2009/10/15